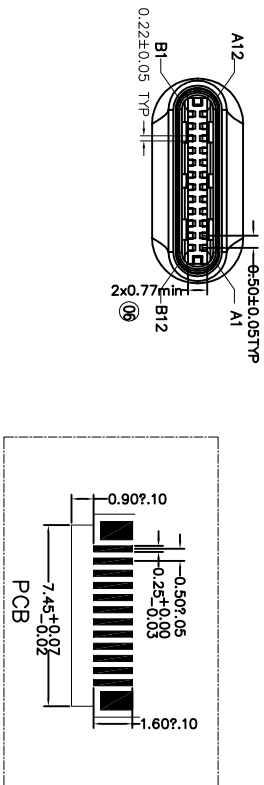
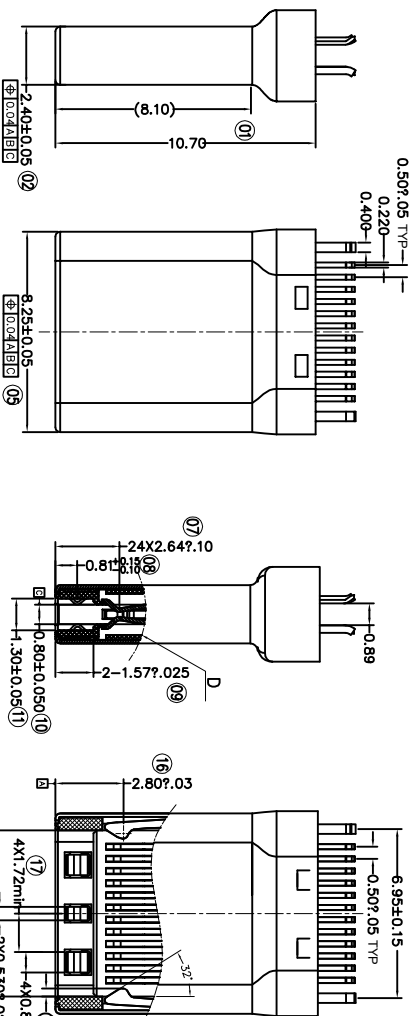
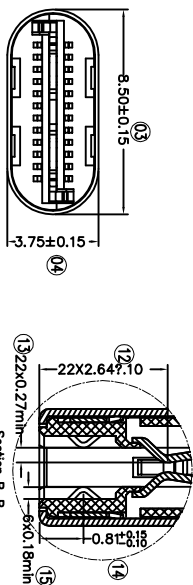


ROHS 客户图



Pin Number	host	device	Pin Number	host	device
Pin A1	GND	GND	Pin B12	GND	GND
Pin A2	SSTxp1	SSTxp1	Pin B11	SSRxp1	SSRxp1
Pin A3	SSTxm1	SSTxm1	Pin B10	SSRxm1	SSRxm1
Pin A4	VBUS	VBUS	Pin B9	VBUS	VBUS
Pin A5	CC1	CC1	Pin B8	SBU2	SBU2
Pin A6	DP1	DP1	Pin B7		
Pin A7	DN1	DN1	Pin B6		
Pin A8	SBU1	SBU1	Pin B5	CC2	CC2
Pin A9	VBUS	VBUS	Pin B4	VBUS	VBUS
Pin A10	SSRxm2	SSRxm2	Pin B3	SSTxm2	SSTxm2
Pin A11	SSRxp2	SSRxp2	Pin B2	SSTxp2	SSTxp2
Pin A12	GND	GND	Pin B1	GND	GND

NOTES

- 1.MATERIAL: See drawing
- 2.STANDARD DATA
- 2.1.Rotating current: 5.0A for VBUS (i.e.pins A4,A9,B4,B9);
1.25A for Veom and GND (i.e.pins B5,A1,A12,B1,B12);
0.25A for all the other contacts.
- 3.ELECTRICAL
 - 3.1.insulator resistance: 100M ohms Min.
 - 3.2.Withstanding voltage: 100 VAC / minute
 - 3.3.Contact resistance: initial 40mohms Max. after 50mohms Max.
- 4.MECHANICAL
 - 4.1.mating force: 5~20N
 - 4.2.unmating force : 8~20N
 - 4.3.Durability: 10000 cycles Min.
 - 5.PACKING: 100pos/tray (reference)

Pin Number	host	device	Pin Number	host	device
6	LATCH	STAINLESS			
5	CONTACT	COPPER ALLOY			
4	molding 2	L.C.P			
3	GNDSPRING	STAINLESS			
2	Molding	L.C.P			
1	SHELL	STAINLESS			

深圳市鑫风雷电子有限公司

公差一览表		单位		比例		日期	
TOLERANCE UNLESS OTHERWISE		UNITS		SCALE		DATE	
X	±0.30	X	±5°	X	1:1	2009/10/20	
X	±0.25	X	±2°	XX	±0.20	XX	XX
XX	±0.15	XX	±1°	XXX	±0.5°		